



SD cards in the Internet of Things

for Flash Memory Summit_SD Association



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The Internet of Things (IoT)

Overview

Why SD Card

Challenges

Mitigation Planning

IoT, **Connecting** vast network of physical devices, systems, and services, intelligently capturing data, and seamlessly exchanging data to vital insight without human-human or human-computer interaction.

■ Market trend :

By 2020, market for **connect devices** will grow to **20 or 30 billion** units.

By 2025, **IoT impact** on the global economy could reach **\$6.2 trillion**.

(Source : McKinsey Global Institute)



IoT - Industry Applications (ATP focus mission-critical ones)

Overview

Why SD Card

Challenges

Mitigation Planning

Industrial (Manuf.)

- Optimized Automation
- Manufacturing Process Control

Retail

- Digital Signage & Advertising
- Retail/Hospitality Kiosk & POS

Transportation

- Vehicles Communication
- Fleet / Traffic Control
- Logistics

Safety & Security

- Surveillance
- Disaster Management
- Emergency Service

Healthcare

- Remote Health Monitoring
- Geriatrics Care
- Tele Health

Utilities

- Smart Grid
- Water , Energy
- Waste



IoT Hardware and SD Card

Overview

Why SD Card

Challenges

Mitigation Planning

The perfect fit for IoT hardware – SD card

■ Why?

Demands [IoT hardware]	Characteristics [SD memory cards]
Space Limitation	<ul style="list-style-type: none">• Small and removable form factor• Available in full size SD and microSD
High Demanding Harsh environment Real-time data transmission	<ul style="list-style-type: none">• Compact build, dust /water and ESD resistance• Low power consumption• High throughput performance
Reliable	<ul style="list-style-type: none">• Detect and error mitigation algorithms to distribute wear and enhance endurance and lifetime• Wide operating and storage temperature range
Safety	<ul style="list-style-type: none">• Digital content security and protection



IoT Challenges – Environment Consideration

Overview

Why SD Card

Challenges

Mitigation Planning

■ Operating under harsh conditions

Devices in the enterprise and industry/infrastructure IoT ecosystem will typically face more extreme challenges, specifically operational and environmental conditions:

- ❑ Extreme temperature (e.g: Heat/High temp cause data retention issue)
- ❑ Humidity
- ❑ Pressure
- ❑ Shock and vibration
- ❑ Ambient radiation
- ❑ Power supply instability



IoT Challenges – Data Consideration (Write)

Overview

Why SD Card

Challenges

Mitigation Planning

■ Frequent Write Small-file Data , typically in bytes (< 1 page size) :

□ Write Amplification Issue

- Frequently writing files < NAND page size
- Used data area > Real data
- High Write Amplification

↑ 'Wear' of NAND flash
↓ Endurance & Usable life



128 Writable Pages in 1 erasable Block

Note: NAND flash is programmed at the page level and erased at the block level.

IoT Challenges – Data Consideration (Read)

Overview

Why SD Card

Challenges

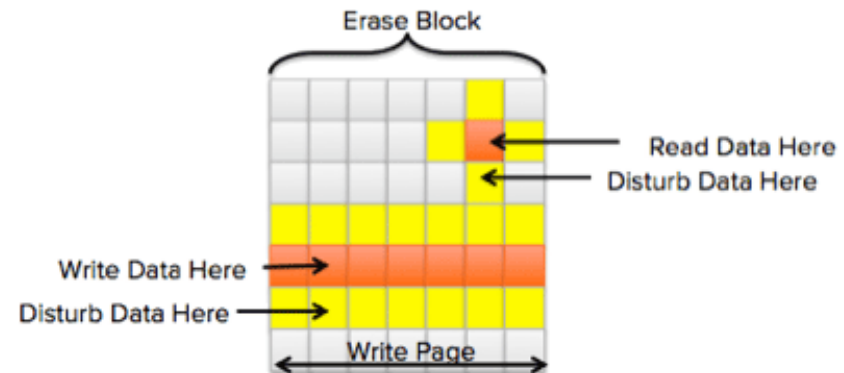
Mitigation Planning

■ Frequent Read Operation System

□ Read Disturb Risk

- Frequently reading without regular wear-leveled write operations

→ Data corruption



■ Seldom Read Application Program

□ Data Retention Concerns

- Loss charge its voltage level over time
- High pre-condition of write/erase cycles
- High ambient temperature

→ Data corruption

IoT Challenges – Product Longevity

Overview

Why SD Card

Challenges

Mitigation Planning

■ Long Term Product Stability

□ BOM issue

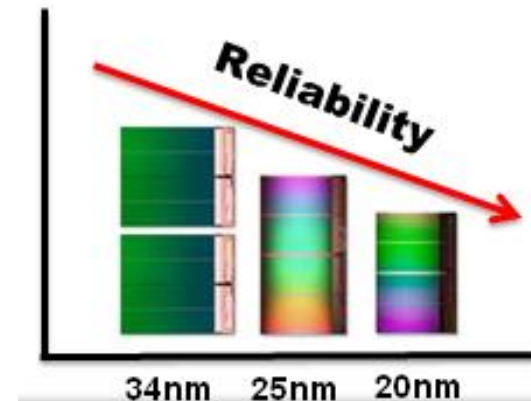
A variation in firmware may result in how the controller conducts NAND flash management or specific reliability features.

□ Dynamic NAND Industry

A roadmap presented during initial qualification is very likely to change due to market influences and process yield/maturity

□ NAND die changes → Changes in reliability

The changes may impact long term reliability of your usage model/IoT devices



Solution – Small yet Robustness

Overview

Why SD Card

Challenges

Mitigation Planning

■ System-In-Package Memory Card Manufacturing

□ Enhanced durability features

- Water proof
- Dust proof
- Shock resistance
- ESD resistance

□ Wafer/die level BOM control

- Controlled die/stacking configuration
- IC packaging level application specific design

IPx7: Water Proof Test

IP5x (microSD) IP6x (SD):

Dust proof test



Solutions –Advanced Technologies

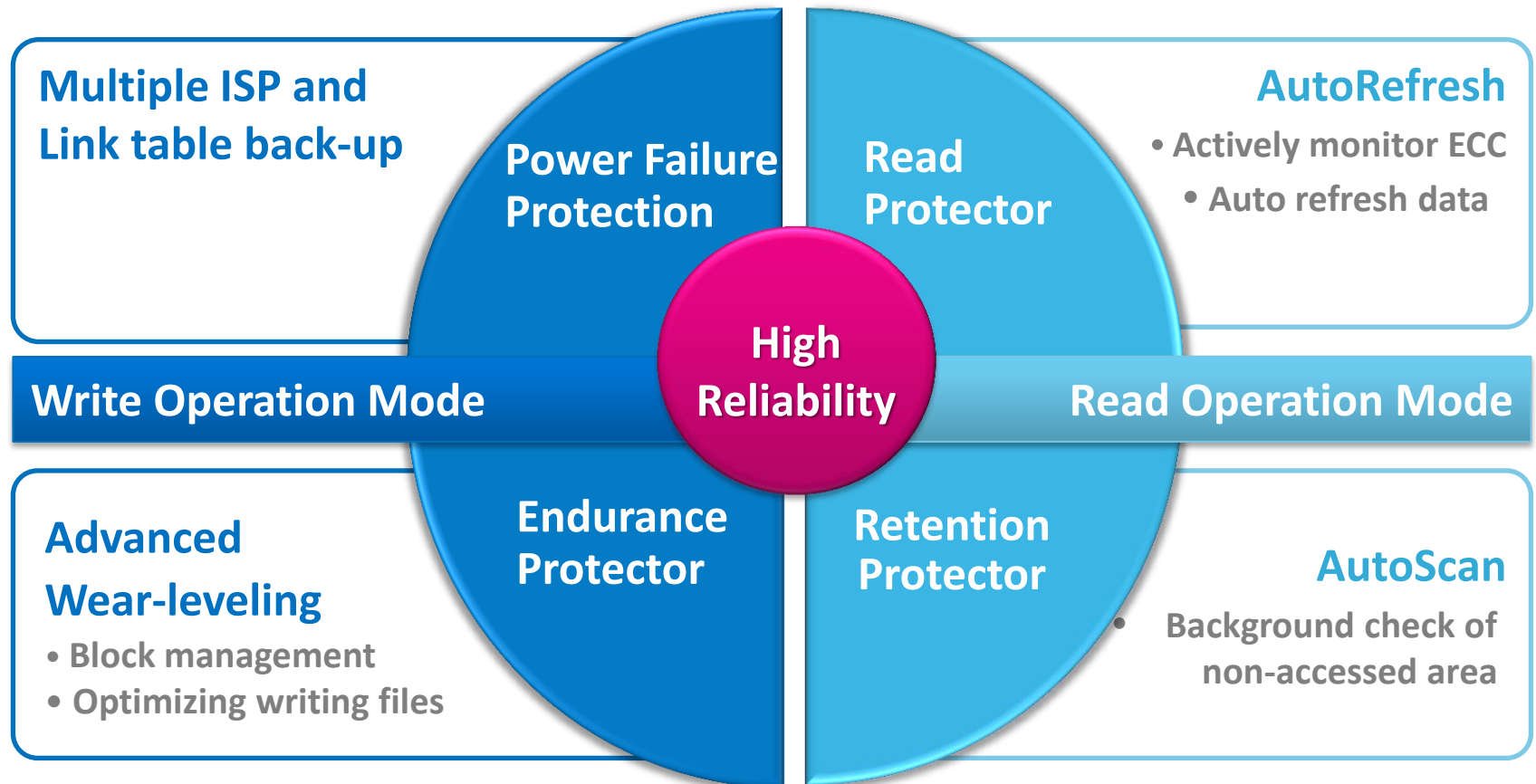
Overview

Why SD Card

Challenges

Mitigation Planning

■ Advanced Technologies



Solutions – Health monitoring software

Overview

Why SD Card

Challenges

Mitigation Planning

- The availability of NAND flash wear and health status monitoring tools and development APIs across typical IoT platforms can be beneficial to the designer and operator alike

- *SD Life Monitor*



```
1)device AF UD appears on /dev/sg1
[INFORMATION SUMMARY].
Flash Brand:                               Micron
Flash Type:                                SLC
Later Bad Block Count:                      0
Average Erase Count:                        2
Total Erase Count:                          6059
Spare Utilization Rate[%]:                  >20
NAND Flash Default Endurance:               60000
Remaining Life[%]:                          100
```

Integrated ATP tool to **Linux** Embedded / Industrial system software (Open source Linux is more popular)

Solution – Rigorous Testing

Overview

Why SD Card

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■ Optimize SD card for IoT applications :



NAND Flash IC Level



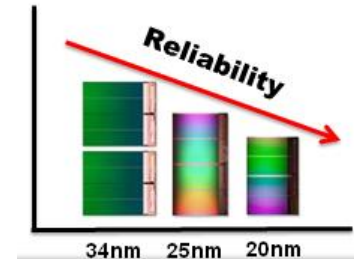
Joint Validation



Mass Production Level

Ensuring the reliability of new NAND die

- Enhanced IC level validation (reliability and functionality)



Client-vendor joint platform/device validation

- Improved SD card **protocol and signal validation testing**
- Compatibility for **new device/card level/ host platform validation**
- Knowledge acquisition and transfer for dynamic process improvement

100% Burn-In Test

- Screen out defects and assure complete reliability at scale

Solution - Supply Chain Risk Aversion

Overview

Why SD Card

Challenges

Mitigation Planning

■ BOM Control

- Required firmware controller and firmware setting level BOM control

■ Long Term Partnership of Key suppliers

- Regularly roadmaps & BOM plan updates from NAND product supplier to avoid surprises
- Work closely with NAND product supplier for smooth qualifications and transitions in supply chain



ATP, Place Highest Value to Serve Your IoT





August 11-13, 2015
Santa Clara, CA

Visit ATP at
Booth No. **729**

Flash Memory Summit Conference Session 302-E: Testing Issues

9:45~10:50, 13th, August

Embedded SSD Product
Challenges and Mitigation

